Vishay Siliconix

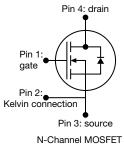
COMPLIANT

HALOGEN

FREE

E Series Power MOSFET





PRODUCT SUMMARY				
V _{DS} (V) at T _J max.	650			
R _{DS(on)} typ. (Ω) at 25 °C	V _{GS} = 10 V 0.155			
Q _g max. (nC)	33			
Q _{gs} (nC)	7			
Q _{gd} (nC)	11			
Configuration	Single			

FEATURES

- 4th generation E series technology
- Low figure-of-merit (FOM) Ron x Qg
- Low effective capacitance (Co(er))
- Reduced switching and conduction losses
- Avalanche energy rated (UIS)
- · Kelvin connection for reduced gate noise
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

APPLICATIONS

- Server and telecom power supplies
- · Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
 - High-intensity discharge (HID)
 - Fluorescent ballast lighting
- Industrial
 - Welding
 - Induction heating
 - Motor drives
 - Battery chargers
 - Solar (PV inverters)

ORDERING INFORMATION	
Package	PowerPAK 8 x 8
Lead (Pb)-free and halogen-free	SiHH180N60E-T1-GE3

PARAMETER			SYMBOL	LIMIT	UNIT
Drain-source voltage			V_{DS}	600	V
Gate-source voltage			V_{GS}	± 30	v
Continuous drain current (T _J = 150 °C)	V at 10 V	T _C = 25 °C T _C = 100 °C	- I _D	19	А
	V _{GS} at 10 V	T _C = 100 °C		12	
Pulsed drain current ^a			I _{DM}	44	
Linear derating factor				0.9	W/°C
Single pulse avalanche energy b			E _{AS}	111	mJ
Maximum power dissipation			P _D	114	W
Operating junction and storage temperature ra	ange		T _J , T _{stg}	-55 to +150	°C
Drain-source voltage slope $T_J = 125$ °C Reverse diode dv/dt °		T _J = 125 °C	dv/dt	70	1//20
		uv/at	22	V/ns	

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature
- b. V_{DD} = 120 V, starting T_J = 25 °C, L = 28.2 mH, R_q = 25 Ω , I_{AS} = 2.8 A
- c. $I_{SD} \leq I_D$, di/dt = 100 A/ μ s, starting T_J = 25 °C



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THERMAL RESISTANCE RATINGS					
PARAMETER	SYMBOL	TYP.	MAX.	UNIT	
Maximum junction-to-ambient	R _{thJA}	42	55	°C/W	
Maximum junction-to-case (drain)	R _{thJC}	0.76	1.1	C/ VV	

PARAMETER	SYMBOL	TES	MIN.	TYP.	MAX.	UNIT	
Static				I			
Drain-source breakdown voltage	V _{DS}	V _{GS} = 0 V, I _D = 250 μA		600	-	-	V
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	Reference to 25 °C, I _D = 1 mA		-	0.63	-	V/°C
Gate-source threshold voltage (N)	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = 250 \mu\text{A}$		3.0	-	5.0	V
		$V_{GS} = \pm 20 \text{ V}$		-	-	± 100	nA
Gate-source leakage	I _{GSS}	,	$V_{GS} = \pm 30 \text{ V}$		-	± 1	μA
Zero gate voltage drain current	I _{DSS}	V _{DS} =	V _{DS} = 600 V, V _{GS} = 0 V		-	1	
		V _{DS} = 480 V	V _{DS} = 480 V, V _{GS} = 0 V, T _J = 125 °C		-	10	μA
Drain-source on-state resistance	R _{DS(on)}	V _{GS} = 10 V	I _D = 9.5 A	-	0.155	0.180	Ω
Forward transconductance ^a	9 _{fs}	V _{DS} =	= 20 V, I _D = 9.5 A	-	5.3	-	S
Dynamic							
Input capacitance	C _{iss}	$V_{GS} = 0 \text{ V},$ $V_{DS} = 100 \text{ V},$ $f = 1 \text{ MHz}$		-	1085	-	pF
Output capacitance	C _{oss}			-	56	-	
Reverse transfer capacitance	C _{rss}			-	5	-	
Effective output capacitance, energy related ^a	C _{o(er)}	V _{DS} = 0 V to 480 V, V _{GS} = 0 V		-	41	-	
Effective output capacitance, time related ^b	C _{o(tr)}			-	251	-	
Total gate charge	Qg			-	22	33	nC
Gate-source charge	Q _{gs}	$V_{GS} = 10 \text{ V}$	$I_{D} = 9.5 \text{ A}, V_{DS} = 480 \text{ V}$		7	-	
Gate-drain charge	Q _{gd}				11	-	
Turn-on delay time	t _{d(on)}	V_{DD} = 480 V, I_{D} = 9.5 A, V_{GS} = 10 V, R_{g} = 9.1 Ω		-	14	28	- ns
Rise time	t _r			-	49	98	
Turn-off delay time	t _{d(off)}			-	22	44	
Fall time	t _f			-	23	46	
Gate input resistance	R_g	f = 1 MHz		0.3	0.7	1.4	Ω
Drain-Source Body Diode Characteristic	s						
Continuous source-drain diode current	I _S	MOSFET symbol showing the integral reverse p - n junction diode		-	-	19	
Pulsed diode forward current	I _{SM}			-	-	44	- A
Diode forward voltage	V _{SD}	T _J = 25 °C, I _S = 9.5 A, V _{GS} = 0 V		-	-	1.2	V
Reverse recovery time	t _{rr}	$T_J = 25 \text{ °C}, I_F = I_S = 9.5 \text{ A},$ $di/dt = 100 \text{ A/}\mu\text{s}, V_R = 25 \text{ V}$		-	282	564	ns
Reverse recovery charge	Q _{rr}			_	3.6	7.2	μC
Reverse recovery current	I _{RRM}			-	24	-	A

Notes

- a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS}
- b. $C_{oss(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS}



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

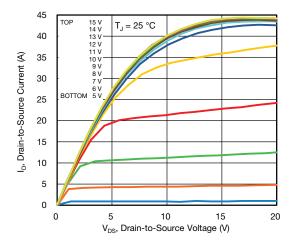


Fig. 1 - Typical Output Characteristics

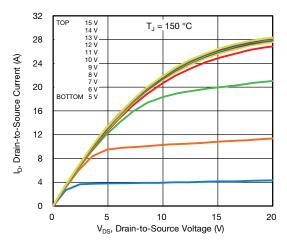


Fig. 2 - Typical Output Characteristics

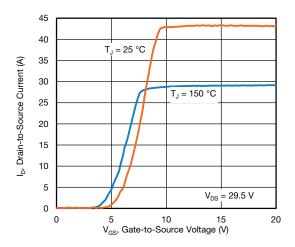


Fig. 3 - Typical Transfer Characteristics

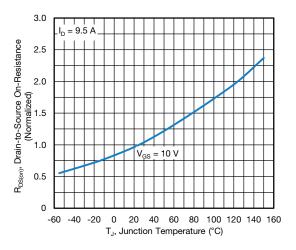


Fig. 4 - Normalized On-Resistance vs. Temperature

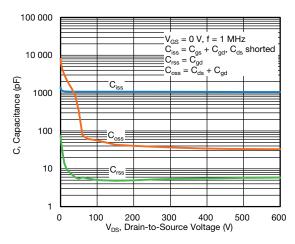


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

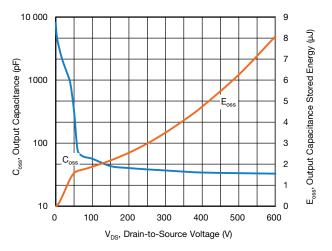


Fig. 6 - C_{oss} and E_{oss} vs. V_{DS}



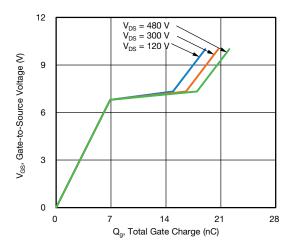


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

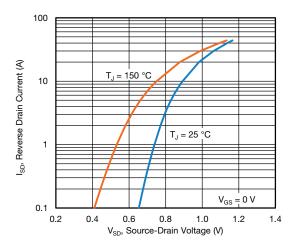


Fig. 8 - Typical Source-Drain Diode Forward Voltage

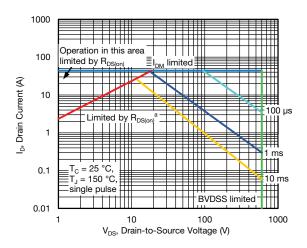


Fig. 9 - Maximum Safe Operating Area

Note

a. V_{GS} > minimum V_{GS} at which $R_{DS(on)}$ is specified

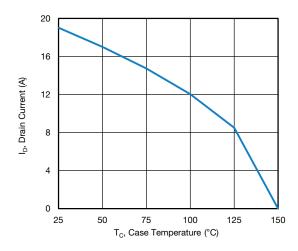


Fig. 10 - Maximum Drain Current vs. Case Temperature

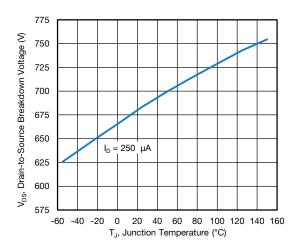


Fig. 11 - Temperature vs. Drain-to-Source Voltage



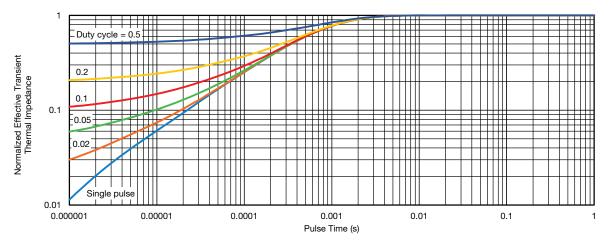


Fig. 12 - Normalized Transient Thermal Impedance, Junction-to-Case

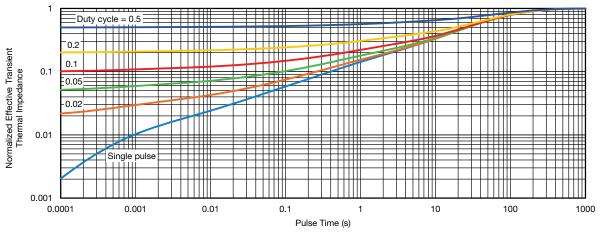


Fig. 13 - Normalized Thermal Transient Impedance, Junction-to-Ambient

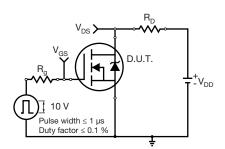


Fig. 14 - Switching Time Test Circuit

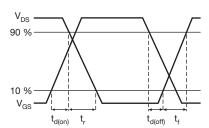


Fig. 15 - Switching Time Waveforms

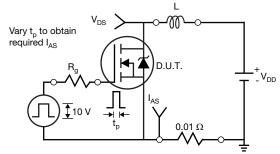


Fig. 16 - Unclamped Inductive Test Circuit

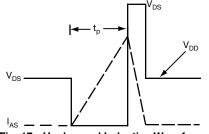


Fig. 17 - Unclamped Inductive Waveforms



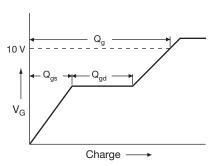


Fig. 18 - Basic Gate Charge Waveform

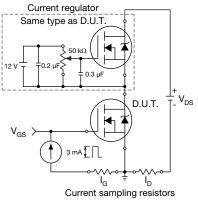
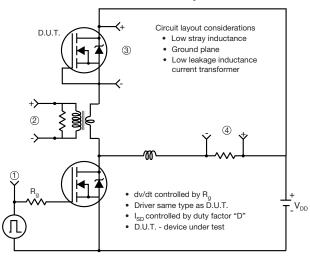


Fig. 19 - Gate Charge Test Circuit

Peak Diode Recovery dv/dt Test Circuit



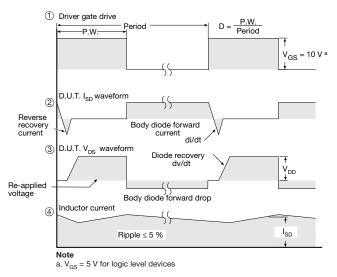


Fig. 20 - For N-Channel

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